

3-Pin Microcontroller Reset Monitors

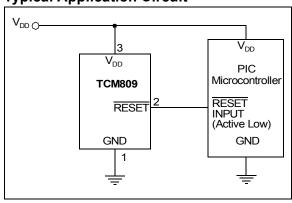
Features

- Precision V_{DD} Monitor for 2.5V, 3.0V, 3.3V, 5.0V Nominal System Voltage Supplies
- · 140 msec Minimum RESET Timeout Period
- RESET Output to V_{DD} = 1.0V (TCM809)
- Low Supply Current, 9 μA (typ.)
- V_{DD} Transient Immunity
- · Small 3-Pin SC-70 and SOT-23B Packages
- · No External Components
- · Push-pull RESET output
- · Temperature Range:
 - Commercial, SC-70(E): -40°C to +85°C
 - Industrial, SOT-23, SC-70(V): -40°C to +125°C

Applications

- · Computers
- · Embedded Systems
- · Battery Powered Equipment
- · Critical Microcontroller Power Supply Monitoring
- Automotive

Typical Application Circuit



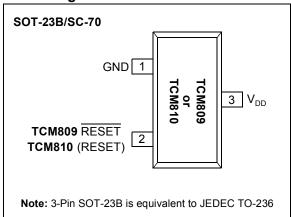
General Description

The TCM809 and TCM810 are cost effective system supervisor circuits designed to monitor V_{DD} in digital systems and provide a reset signal to the host processor when necessary. No external components are required.

The RESET output is typically driven active within 20 µsec (SOT-23) or 65 µsec (SC-70) of V_{DD} falling through the reset voltage threshold. RESET is maintained active for a minimum of 140 msec after V_{DD} rises above the reset threshold. The TCM810 has an active-high RESET output while the TCM809 has an active-low RESET output. The output of the TCM809/ TCM810 is valid down to V_{DD} = 1V. Both devices are available in 3-Pin SOT-23B and SC-70 packages.

The TCM809/TCM810 are optimized to reject fast transient glitches on the V_{DD} line. Low supply current of 9 μ A (typ., V_{DD} = 3.3V) makes these devices suitable for battery powered applications.

Pin Configurations



1.0 **ELECTRICAL CHARACTERISTICS**

ABSOLUTE MAXIMUM RATINGS*

Supply Voltage (V _{DD} to GND)6.0V
RESET, RESET – 0.3V to (V _{DD} +0.3V)
Input Current, V _{DD} 20 mA
Output Current, RESET, RESET20 mA
dV/dt (V _{DD})100V/µsec
Operating Temperature Range 40°C to +125°C
Power Dissipation (T _A = 70°C): 3-Pin SOT-23B (derate 4 mW/°C above +70°C)320 mW 3-Pin SC-70 (derate 2.17 mW/°C above +70°C)174 mW
Storage Temperature Range – 65°C to +150°C
Maximum Junction Temperature, T _J 150°C

^{*}Notice: Stresses above those listed under "Maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

PIN FUNCTION TABLE

NAME	FUNCTION
GND	Ground
RESET (TCM809)	RESET push-pull output remains low while V _{DD} is below the reset voltage threshold and for 240 msec (140 msec min.) after V _{DD} rises above reset threshold.
RESET (TCM810)	RESET push-pull output remains high while V _{DD} is below the reset voltage threshold and for 240 msec (140 msec min.) after V _{DD} rises above reset threshold.
V_{DD}	Supply voltage (+2.5V, +3.0V, +3.3V, +5.0V)

ELECTRICAL CHARACTERISTICS

 V_{DD} = Full Range, T_A = Operating Temperature Range, unless otherwise noted. Typical values are at T_A = +25°C, V_{DD} = 5V for L/M/J, 3.3V for T/S, 3.0V for R, and 2.5V for Z (**Note 1**).

Parameter	Sym	Min	Тур	Max	Units	Test Conditions
V _{DD} Range		1.0 1.2		5.5 5.5	V	$T_A = 0^{\circ}C \text{ to } +70^{\circ}C$ $T_A = -40^{\circ}C \text{ to } +125^{\circ}C$
Supply Current (SOT-23)	I _{CC}	_	24 17	60 50	μА	TCM8xxL/M: $V_{DD} < 5.5V$ TCM8xxR/S/T/Z: $V_{DD} < 3.6V$
Supply Current (SC-70)	I _{CC}	_	12 9	30 25	μA	TCM8xxL/M/J: $V_{DD} < 5.5V$ TCM8xxR/S/T/Z: $V_{DD} < 3.6V$
Reset Threshold (Note 2)	V_{TH}	4.56 4.50	4.63 —	4.70 4.75	V	TCM8xxL: $T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ to +125°C
		4.31 4.25	4.38 —	4.45 4.50		TCM8xxM: $T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ to +125°C
		3.93 3.89	4.00 —	4.06 4.10		TCM809J: $T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ to +125°C
		3.04 3.00	3.08	3.11 3.15		TCM8xxT: $T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ to +125°C
		2.89 2.85	2.93 —	2.96 3.00		TCM8xxS: $T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ to +125°C
		2.59 2.55	2.63 —	2.66 2.70		TCM8xxR: $T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ to +125°C
		2.28 2.25	2.32	2.35 2.38		TCM8xxZ: $T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ to +125°C
Reset Threshold Tempco		_	30	_	ppm/°C	
V _{DD} to Reset Delay, SOT-23		_	20	_	μsec	$V_{DD} = V_{TH}$ to $(V_{TH} - 100 \text{ mV})$ (Note 2)
V _{DD} to Reset Delay, SC-70		_	65	_	µsec	$V_{DD} = V_{TH}$ to $(V_{TH} - 100 \text{ mV})$ (Note 2)
Reset Active Time-out Period, SOT-23		140	240	560	msec	
Reset Active Time-out Period, SC-70		140	320	560	msec	
RESET Output Voltage Low (TCM809)	V _{OL}	_ _ _	_ _ _	0.3 0.4 0.3	V	TCM809R/S/T/Z: $V_{DD} = V_{TH}$ min, $I_{SINK} = 1.2$ mA TCM809L/M/J: $V_{DD} = V_{TH}$ min, $I_{SINK} = 3.2$ mA $V_{DD} > 1.0V$, $I_{SINK} = 50$ μ A
RESET Output Voltage High (TCM809)	V _{OH}	0.8 V _{DD} V _{DD} – 1.5			V	TCM809R/S/T/Z: $V_{DD} > V_{TH}$ max, I_{SOURCE} = 500 μ A TCM809L/M/J: $V_{DD} > V_{TH}$ max, I_{SOURCE} = 800 μ A

Production testing done at T_A = +25°C, over temperature limits ensured by QC screen. RESET Output for TCM809, RESET Output for TCM810. Note

 V_{DD} = Full Range, T_A = Operating Temperature Range, unless otherwise noted. Typical values are at T_A = +25°C, V_{DD} = 5V for L/M/J, 3.3V for T/S, 3.0V for R, and 2.5V for Z (**Note 1**).

Parameter	Sym	Min	Тур	Max	Units	Test Conditions
RESET Output Voltage Low (TCM810)	V _{OL}	_	1 1	0.3 0.4	V	$ \begin{array}{ll} \text{TCM810R/S/T/Z: V}_{\text{DD}} = \text{V}_{\text{TH}} \text{ max, I}_{\text{SINK}} = 1.2 \text{ mA} \\ \text{TCM810L/M:} & \text{V}_{\text{DD}} = \text{V}_{\text{TH}} \text{ max, I}_{\text{SINK}} = 3.2 \text{ mA} \\ \end{array} $
RESET Output Voltage High (TCM810)	V _{OH}	0.8 V _{DD}	_	_	V	$1.8 < V_{DD} < V_{TH}$ min, $I_{SOURCE} = 150 \mu A$

 $\frac{\text{Production testing done at T}_{\text{A}} = +25^{\circ}\text{C}, \text{ over temperature limits ensured by QC screen.}}{\text{RESET Output for TCM809}, \text{RESET Output for TCM810}}.$ Note

2.0 APPLICATIONS INFORMATION

2.1 VDD Transient Rejection

The TCM809/TCM810 provides accurate V_{DD} monitoring and reset timing during power-up, power-down, and brownout/sag conditions. These devices also reject negative-going transients (glitches) on the power supply line. Figure 2-1 shows the maximum transient duration vs. maximum negative excursion (overdrive) for glitch rejection. Any combination of duration and overdrive which lies under the curve will not generate a reset signal.

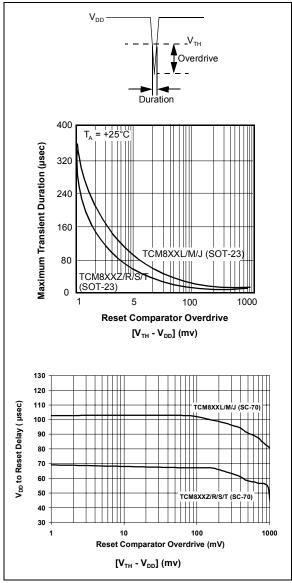


FIGURE 2-1: Maximum Transient Duration vs. Overdrive for Glitch Rejection at 25°C.

Combinations above the curve are detected as a brownout or power-down condition. Transient immunity can be improved by adding a capacitor in close proximity to the V_{DD} pin of the TCM809/TCM810.

2.2 <u>RESET Signal Integrity During</u> Power-Down

The TCM809 $\overline{\text{RESET}}$ output is valid to V_{DD} = 1.0V. Below this voltage the output becomes an "open circuit" and does not sink current. This means CMOS logic inputs to the microcontroller will be floating at an undetermined voltage. Most digital systems are completely shutdown well above this voltage. However, in situations where RESET must be maintained valid to V_{DD} = 0V, a pull-down resistor must be connected from RESET to ground to discharge stray capacitances and hold the output low (Figure 2-2). This resistor value, though not critical, should be chosen such that it does not appreciably load RESET under normal operation (100 $k\Omega$ will be suitable for most applications). Similarly, a pull-up resistor to $V_{\mbox{\scriptsize DD}}$ is required for the TCM810 to ensure a valid high RESET for V_{DD} below 1.0V.

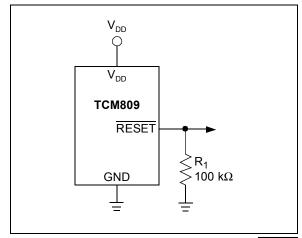


FIGURE 2-2: The addition of R_1 at the RESET output of the TCM809 ensures that the RESET output is valid to $V_{DD} = 0V$.

2.3 Controllers and Processors With Bidirectional I/O Pins

Some microcontrollers have bi-directional reset pins. Depending on the current drive capability of the controller pin, an indeterminate logic level may result if there is a logic conflict. This can be avoided by adding a 4.7 k Ω resistor in series with the output of the TCM809/ TCM810 (Figure 2-3). If there are other components in the system which require a reset signal, they should be buffered so as not to load the reset line. If the other components are required to follow the reset I/O of the microcontroller, the buffer should be connected as shown with the solid line.

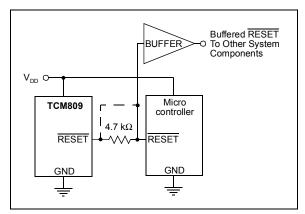


FIGURE 2-3: Interfacing the TCM809 to a Bidirectional RESET I/O.

3.0 TYPICAL PERFORMANCE CHARACTERISTICS

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

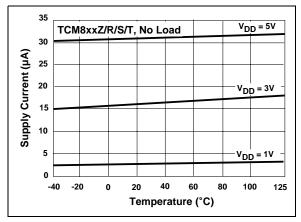


FIGURE 3-1: Supply Current vs. Temperature, SOT-23.

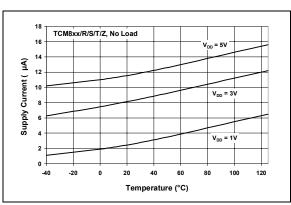


FIGURE 3-2: Supply Current vs. Temperature, SC-70.

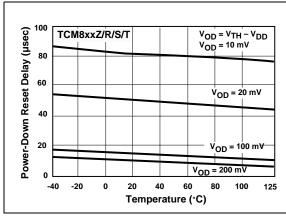


FIGURE 3-3: Power-Down Reset Delay vs. Temperature, SOT-23.

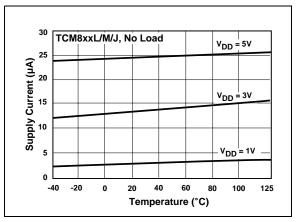


FIGURE 3-4: Supply Current vs. Temperature, SOT-23.

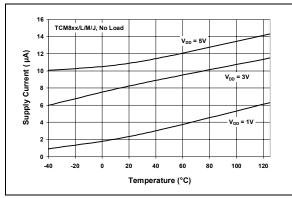


FIGURE 3-5: Supply Current vs. Temperature, SC-70.

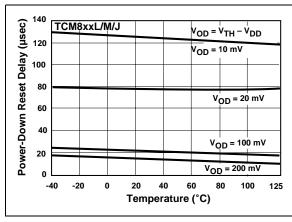


FIGURE 3-6: Power-Down Reset Delay vs. Temperature, SOT-23.

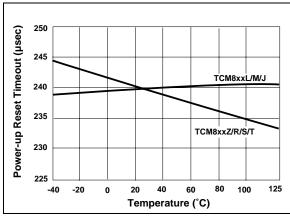


FIGURE 3-7: Power-Up Reset Time-out vs. Temperature, SOT-23.

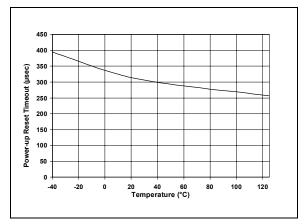


FIGURE 3-8: Power-up Reset Time-out vs. Temperature, SC-70.

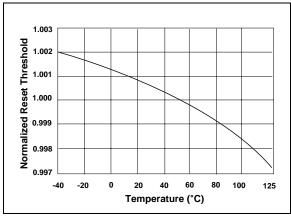


FIGURE 3-9: Normalized Reset Threshold vs. Temperature, SOT-23.

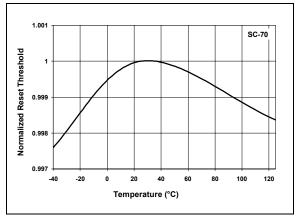
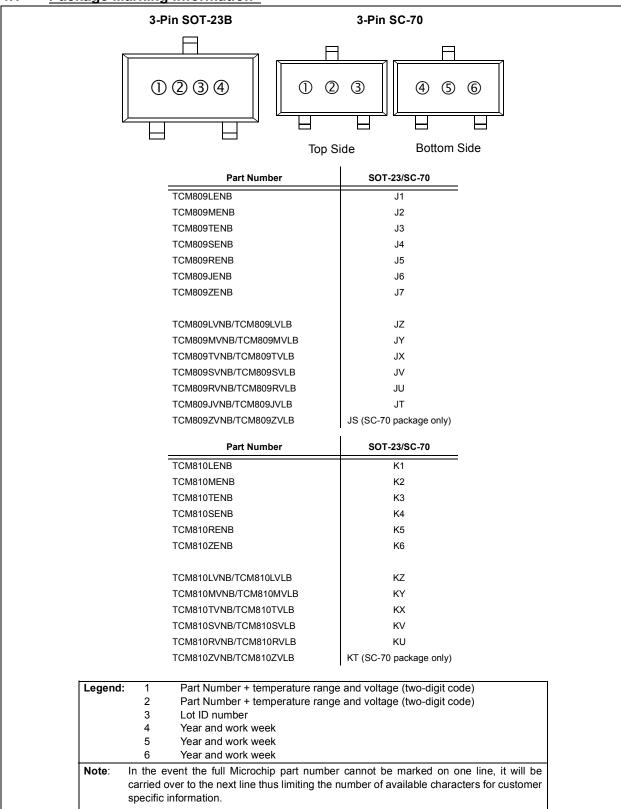


FIGURE 3-10: Normalized Reset Threshold vs. Temperature, SC-70.

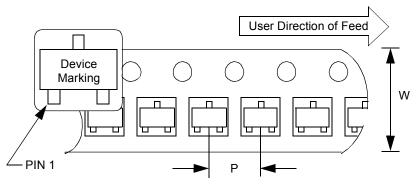
4.0 PACKAGING INFORMATION

4.1 Package Marking Information



4.2 Taping Form



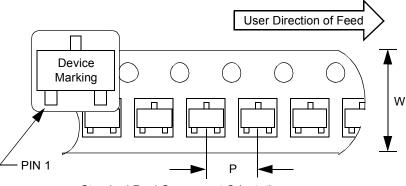


Standard Reel Component Orientation for 713 Suffix Device (Mark Right Side Up)

Carrier Tape, Number of Components Per Reel and Reel Size:

Package	Carrier Width (W)	Pitch (P)	Part Per Full Reel	Reel Size
3-Pin SOT-23B	8 mm	4 mm	3000	7 in.

Component Taping Orientation for 3-Pin SC-70 (EIAJ) Devices

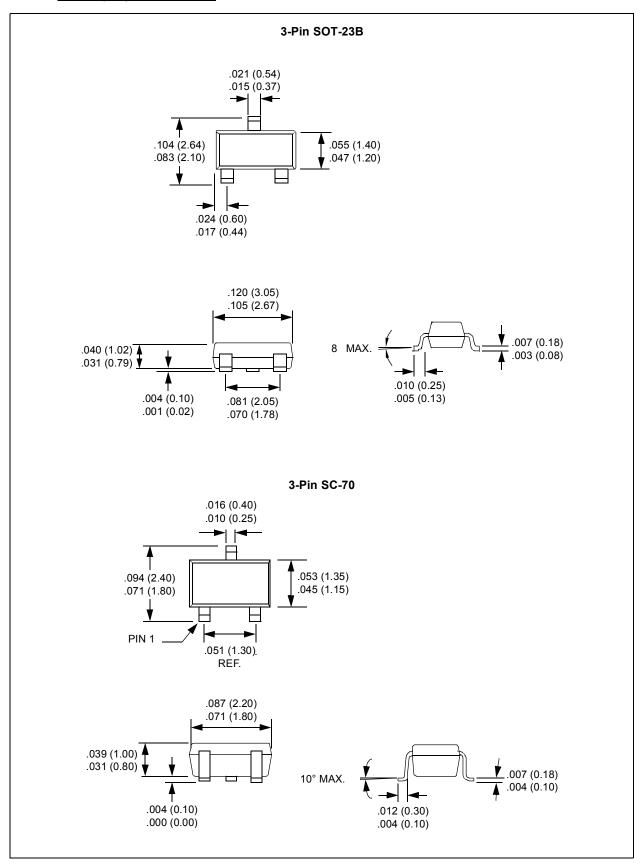


Standard Reel Component Orientation for 713 Suffix Device (Mark Right Side Up)

Carrier Tape, Number of Components Per Reel and Reel Size:

Package	Carrier Width (W)	Pitch (P)	Part Per Full Reel	Reel Size
3-Pin SC-70	8 mm	4 mm	3000	7 in.

4.3 Packaging Information



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PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	X	X	xxxxx
	V _{DD} Reset reshold	Temperature Range	Package
Device:			n active-low RESET output n active-high RESET output
V _{DD} Reset Threshold:	L = 4. M = 4. J = 4. T = 3. S = 2. R = 2. Z = 2.	38V 00V 08V 93V 63V	
Temperature Range:		0°C to +85°C 0°C to +125°C	
Package:		SOT-23B, 3-pin (Tape SC-70, 3-pin (Tape a	

Examples:

- TCM809LENB713: SOT-23B-3-TR, Microcontroller 4.63V Reset Monitor, -40°C to +85°C, Tape and Reel.
- TCM809LVLB713: SC-70-3-TR, Microcontroller 4.63V Reset Monitor, -40°C to +125°C, Tape and Reel.
- TCM809LVNB713: SOT-23B-3-TR, Microcontroller 4.63V Reset Monitor, -40°C to +125°C, Tape and Reel.
- TCM810MENB713: SOT-23B-3-TR, Microcontroller 2.63V Reset Monitor, -40°C to +85°C, Tape and Reel.
- TCM810RVLB713: SOT-23B-3-TR, Microcontroller 2.63V Reset Monitor, -40°C to +125°C, Tape and Reel.
- TCM810TVLB713: SC-70-3-TR, Microcontroller 2.63V Reset Monitor, -40°C to +125°C, Tape and Reel.

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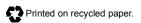
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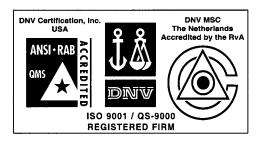
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